# 3.5mm Earphone Audio Connector PCB Mount





## **Specifications**

### **Electrical Data**

Contact Resistance :  $30m\Omega$  max.

Withstanding Voltage : 500V AC for one minute Insulation Resistance :  $100M\Omega$  min.at 500V DC

#### Material

Housing / Body : PA66 (Body)
Flammability : UL94HB

Contact : Phosphor bronze (Sleeve spring, Ring spring #2, Ring spring #3, Chip spring)

Plating : Ag

### **Mechanical Data**

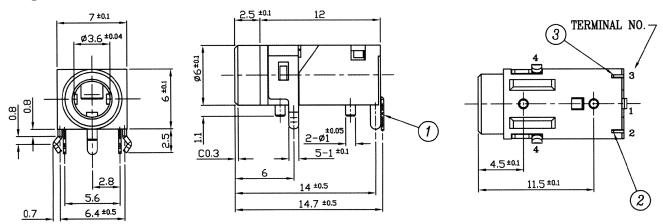
Mating Cycles : 5,000 (gauge plug)

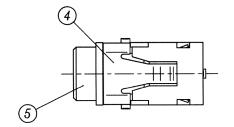
Insertion Force : 5.88 to 24.52N (initial value), 2.94 to 19.62N (after insertion and extraction) Extraction Force : 5.88 to 24.52N (initial value), 2.94 to 19.62N (after insertion and extraction)

#### **Environmental**

Temperature Range : -20°C to +70°C

# **Diagram**





No.	Part Name	Material	Remark	Qty.
1	Sleeve Spring	PBs 0.25t	Ag-Plated	
2	Ring Spring #2	PBs 0.25t	Ag-Plated	
3	Ring Spring #3	PBs 0.25t	Ag-Plated	1
4	Chip Spring	PBs 0.4t	Ag-Plated	
5	Body	PA66/CF Resin	Black	

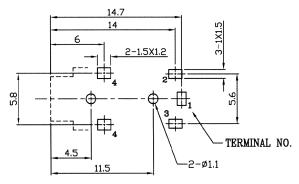
Dimensions: Millimetres

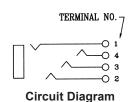
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# 3.5mm Earphone Audio Connector PCB Mount







PC Board Hole Layout (Tolerance: ±0.1)

Dimensions: Millimetres

## **Part Number Table**

Description	Part Number	
3.5mm Earphone Audio Connector, PCB Mount	MJ-2135	

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